STL15N65M5



N-channel 650 V, 0.335 Ω typ., 10 A MDmesh™ M5 Power MOSFET in a PowerFLAT™ 5x6 HV package

Datasheet - production data

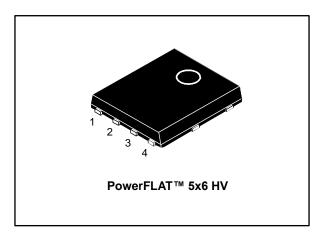
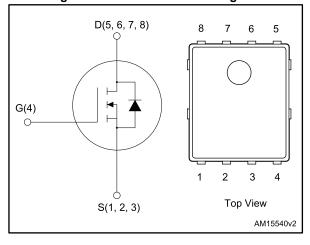


Figure 1: Internal schematic diagram



Features

Order code	V DS @ TJ max. RDS(on) max		ΙD
STL15N65M5	710 V	0.375 Ω	10 A

- Extremely low R_{DS(on)}
- Low gate charge and input capacitance
- Excellent switching performance
- 100% avalanche tested

Applications

Switching applications

Description

This device is an N-channel Power MOSFET based on the MDmesh™ M5 innovative vertical process technology combined with the well-known PowerMESH™ horizontal layout. The resulting product offers extremely low onresistance, making it particularly suitable for applications requiring high power and superior efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing	l
STL15N65M5	15N65M5	PowerFLAT™ 5x6 HV	Tape and reel	l

Contents STL15N65M5

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STL15N65M5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	650	V
V_{GS}	Gate-source voltage	± 25	V
I _D	Drain current (continuous) at T _C = 25 °C	10	Α
ΙD	Drain current (continuous) at T _C = 100 °C	5	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	40	Α
Ртот	Total dissipation at $T_C = 25$ °C	52	W
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T_j max)	2.5	А
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	160	mJ
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
T _{stg}	Storage temperature range	55 to 150	°C
Tj	Operating junction temperature range	- 55 to 150	°C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	2.4	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	59	°C/W

Notes:

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by safe operating area.

 $^{^{(2)}}I_{SD} \leq 10 \text{ A, di/dt} \leq 400 \text{ A/}\mu\text{s, } V_{DS(peak)} \\ \leq V_{(BR)DSS}, \ V_{DD} = 400 \text{ V}.$

⁽¹⁾When mounted on 1inch² FR-4 board, 2 oz Cu.

Electrical characteristics STL15N65M5

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4: On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	650			V
	Zero gate voltage	V _{DS} = 650 V			1	μΑ
IDSS	drain current	$V_{DS} = 650 \text{ V}, T_{C} = 125 \text{ °C } ^{(1)}, V_{GS} = 0 \text{ V}$			100	μΑ
Igss	Gate-body leakage current	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$			± 100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 5 A		0.335	0.375	Ω

Notes:

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	816	-	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	23	-	pF
Crss	Reverse transfer capacitance	$V_{GS} = 0 V$	-	2.6	-	pF
C _{o(tr)} (1)	Equivalent capacitance time related	V 0 to 520 V V 0 V	-	70	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	$V_{DS} = 0$ to 520 V, $V_{GS} = 0$ V		21	-	pF
R _G	Intrinsic gate resistance	f = 1 MHz open drain	-	5	-	Ω
Q_g	Total gate charge $V_{DD} = 520 \text{ V}, I_D = 5.5 \text{ A},$		-	22	-	nC
Q_{gs}	Gate-source charge	V _{GS} = 10 V	-	5.5	-	nC
Q_{gd}	Gate-drain charge	(see Figure 16: "Test circuit for gate charge behavior")	-	11	-	nC

Notes:

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⁽¹⁾Defined by design, not subject to production test.

 $^{^{(1)}}$ Coss eq. time related is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80 % VDss.

 $^{^{(2)}}$ Coss eq. energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when VDs increases from 0 to 80 % VDss.

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t _{d(V)}	Voltage delay time	$V_{DD} = 400 \text{ V}, I_D = 7 \text{ A},$	-	30	-	ns
t _{r(V)}	Voltage rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$	-	8	-	ns
t _{f(I)}	Current fall time	(see Figure 17: "Test circuit for inductive load switching and	-	11	-	ns
$t_{c(off)}$	Crossing time	diode recovery times" and Figure 20: "Switching time waveform")	-	12.5	-	ns

Table 7: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		10	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		1		40	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 10 \text{ A}, V_{GS} = 0$	-		1.5	V
t _{rr}	Reverse recovery time	I _{SD} = 10 A, di/dt = 100 A/μs	-	244		ns
Qrr	Reverse recovery charge	V _{DD} = 100 V	-	2.35		μC
I _{RRM}	Reverse recovery current	(see Figure 17: "Test circuit for inductive load switching and diode recovery times")	-	19.2		А
t _{rr}	Reverse recovery time	I _{SD} = 10 A, di/dt = 100 A/µs	-	308		ns
Qrr	Reverse recovery charge	$V_{DD} = 100 \text{ V}, T_j = 150 ^{\circ}\text{C}$	-	2.93		μC
I _{RRM}	Reverse recovery current	(see Figure 17: "Test circuit for inductive load switching and diode recovery times")	-	19		А

Notes:

⁽¹⁾Pulse width limited by safe operating area.

 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5 %.

2.1 Electrical characteristics (curves)

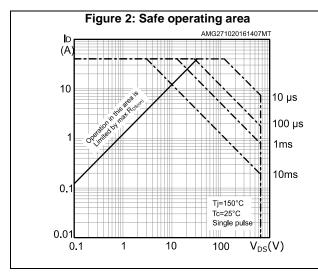
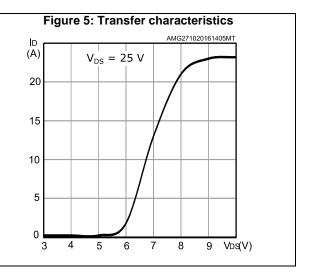
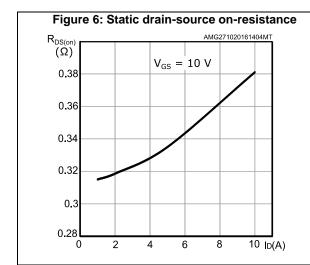
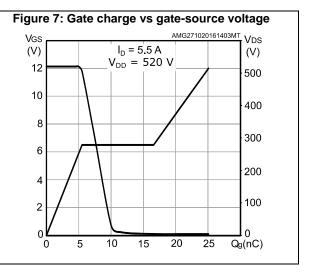


Figure 3: Thermal impedance

K $\delta = 0.5$ 0.2 0.02 0.01 0.05 0.02 0.01 0.02 0.01 0.05 0.02 0.01 0.01 0.05 0.02 0.01 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01 0.05 0.02 0.01







STL15N65M5 Electrical characteristics

Figure 8: Capacitance variations

C
(pF)

1000

Ciss

Coss

Coss

10

10

100

100

Coss

Crss

Figure 9: Output capacitance stored energy

Eoss
(µJ)
4
3.5
3
2.5
2
1.5
0
0 100 200 300 400 500 600 V_{DS}(V)

Figure 10: Normalized gate threshold voltage vs temperature

VGS(th) _______AMG271020161414MT

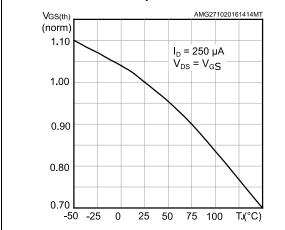


Figure 11: Normalized on-resistance vs temperature

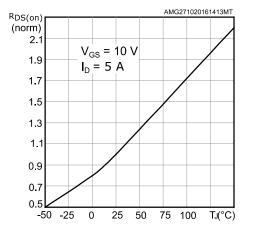


Figure 12: Source-drain diode forward characteristics

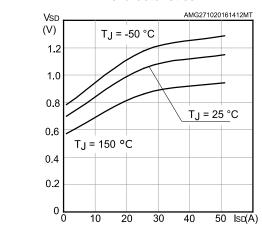
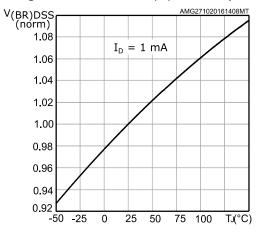
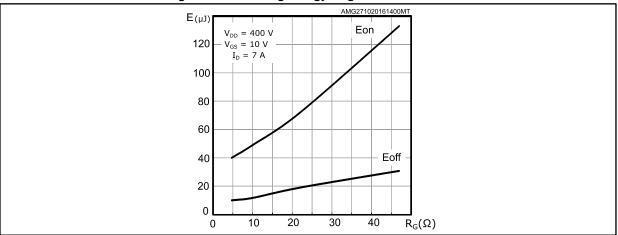


Figure 13: Normalized V_{(BR)DSS} vs temperature







Notes:

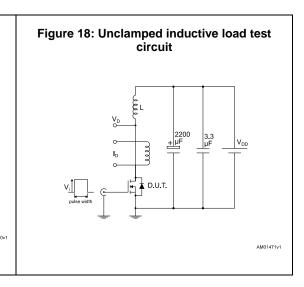
 $[\]ensuremath{^{(1)}}\xspace$ Eon including reverse recovery of a SiC diode.

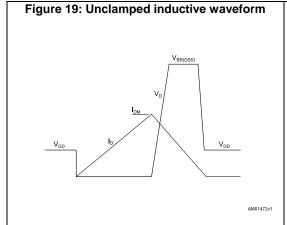
STL15N65M5 Test circuits

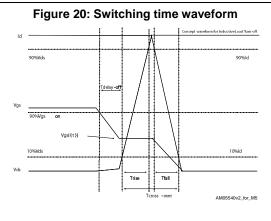
3 Test circuits

Figure 15: Test circuit for resistive load switching times

Figure 17: Test circuit for inductive load switching and diode recovery times







Package information STL15N65M5

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

STL15N65M5 Package information

4.1 Power Flat™ 5x6 HV package information

Figure 21: PowerFLAT™ 5x6 HV package outline

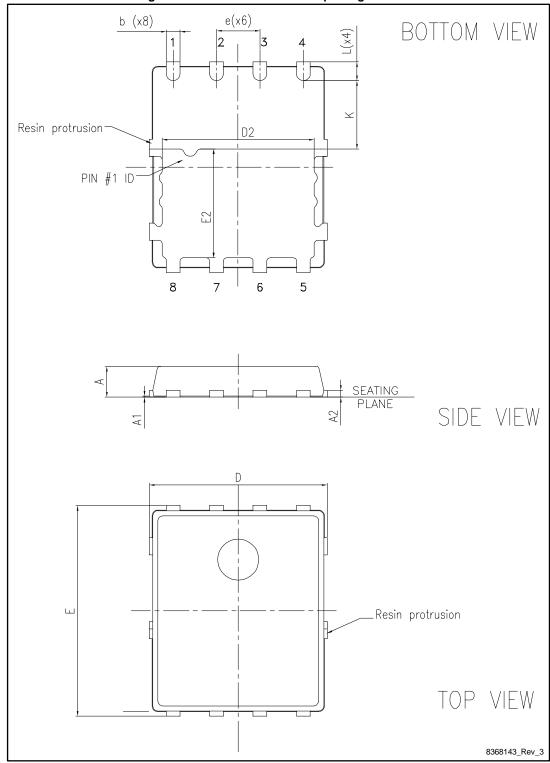
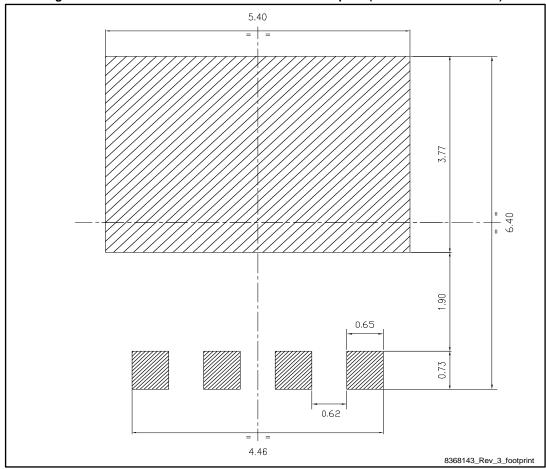


Table 8: PowerFLAT™ 5x6 HV mechanical data

		mm	
Dim.	Min.	Тур.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
D	5.10	5.20	5.30
Е	6.05	6.15	6.25
E2	3.10	3.20	3.30
D2	4.30	4.40	4.50
е		1.27	
L	0.50	0.55	0.60
K	1.90	2.00	2.10

Figure 22: PowerFLAT™ 5x6 HV recommended footprint (dimensions are in mm)



STL15N65M5 Package information

4.2 Power Flat™ 5x6 HV packing information

Figure 23: PowerFLAT™ 5x6 tape (dimensions are in mm)

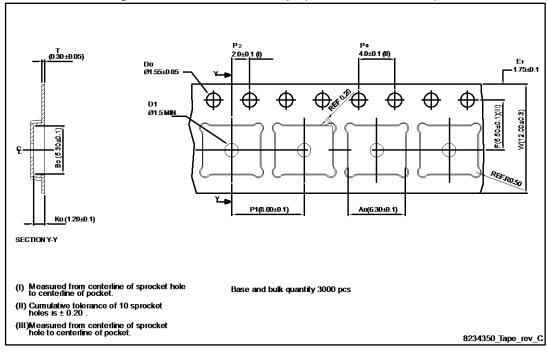
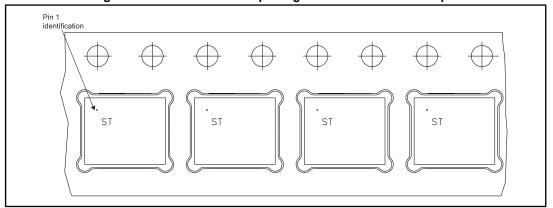


Figure 24: PowerFLAT™ 5x6 package orientation in carrier tape



STL15N65M5 Revision history

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
26-Jun-2013	1	First release
05-Dec-2016	2	Updated title, features and description in cover page. Updated Figure 1: "Internal schematic diagram", Table 2: "Absolute maximum ratings" and Section 4: "Package information". Minor text changes.

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